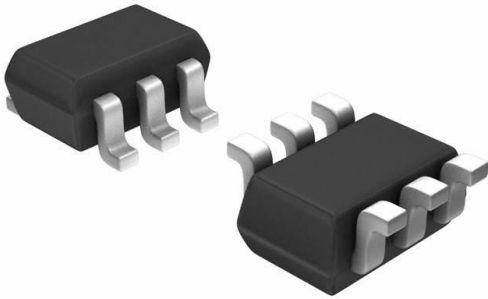


# NTJD4158CT1G Datasheet

[www.digi-electronics.com](http://www.digi-electronics.com)



<https://www.DiGi-Electronics.com>

DiGi Electronics Part Number	NTJD4158CT1G-DG
Manufacturer	<a href="#">onsemi</a>
Manufacturer Product Number	NTJD4158CT1G
Description	MOSFET N/P-CH 30V/20V SC88
Detailed Description	Mosfet Array 30V, 20V 250mA, 880mA 270mW Surface Mount SC-88/SC70-6/SOT-363



Tel: +00 852-30501935

RFQ Email: [Info@DiGi-Electronics.com](mailto:Info@DiGi-Electronics.com)

DiGi is a global authorized distributor of electronic components.

## Purchase and inquiry

Manufacturer Product Number:

NTJD4158CT1G

Series:

-

Technology:

MOSFET (Metal Oxide)

FET Feature:

Logic Level Gate

Current - Continuous Drain (Id) @ 25°C:

250mA, 880mA

Vgs(th) (Max) @ Id:

1.5V @ 100µA

Input Capacitance (Ciss) (Max) @ Vds:

33pF @ 5V

Operating Temperature:

-55°C ~ 150°C (Tj)

Package / Case:

6-TSSOP, SC-88, SOT-363

Base Product Number:

NTJD4158

Manufacturer:

onsemi

Product Status:

Active

Configuration:

N and P-Channel

Drain to Source Voltage (Vdss):

30V, 20V

Rds On (Max) @ Id, Vgs:

1.50hm @ 10mA, 4.5V

Gate Charge (Qg) (Max) @ Vgs:

1.5nC @ 5V

Power - Max:

270mW

Mounting Type:

Surface Mount

Supplier Device Package:

SC-88/SC70-6/SOT-363

## Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.21.0095

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99



# NTJD4158C, NVJD4158C

## MOSFET – Small Signal, Complementary, SC-88 30 V/-20 V, +0.25/-0.88 A



ON Semiconductor®

[www.onsemi.com](http://www.onsemi.com)

### Features

- Leading 20 V Trench for Low  $R_{DS(on)}$  Performance
- ESD Protected Gate
- SC-88 Package for Small Footprint (2 x 2 mm)
- NV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### Applications

- DC-DC Conversion
- Load/Power Management
- Load Switch
- Cell Phones, MP3s, Digital Cameras, PDAs

### MAXIMUM RATINGS ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage	N-Ch	$V_{DSS}$	30	V	
	P-Ch		-20		
Gate-to-Source Voltage	N-Ch	$V_{GS}$	$\pm 20$	V	
	P-Ch		$\pm 12$		
N-Channel Continuous Drain Current (Note 1)	Steady State	$T_A = 25^\circ\text{C}$	$I_D$	0.25	A
		$T_A = 85^\circ\text{C}$		0.18	
P-Channel Continuous Drain Current (Note 1)	Steady State	$T_A = 25^\circ\text{C}$		-0.88	
		$T_A = 85^\circ\text{C}$		-0.63	
Power Dissipation (Note 1)	Steady State	$T_A = 25^\circ\text{C}$	$P_D$	0.27	W
Pulsed Drain Cur- rent	N-Ch	$t_p = 10 \mu\text{s}$	$I_{DM}$	0.5	A
	P-Ch			-3.0	
Operating Junction and Storage Temperature		$T_J, T_{stg}$	-55 to 150	$^\circ\text{C}$	
Source Current (Body Diode)	N-Ch	$I_S$	0.25	A	
	P-Ch		-0.48		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		$T_L$	260	$^\circ\text{C}$	

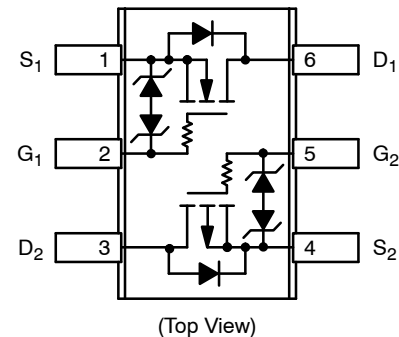
### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient – Steady State (Note 1)	$R_{\theta JA}$	460	$^\circ\text{C}/\text{W}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

$V_{(BR)DSS}$	$R_{DS(on)}$ Typ	$I_D$ Max
N-Ch 30 V	1.0 $\Omega$ @ 4.5 V	0.25 A
	1.5 $\Omega$ @ 2.5 V	
P-Ch -20 V	215 m $\Omega$ @ -4.5 V	-0.88 A
	345 m $\Omega$ @ -2.5 V	

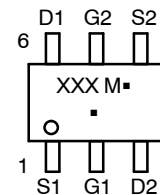
SC-88 (SOT-363)  
(6-Leads)



### MARKING DIAGRAM & PIN ASSIGNMENT



SC-88 (SOT-363)  
CASE 419B  
STYLE 26



XXX = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

**NTJD4158C, NVJD4158C**

1. Surface mounted on FR4 board using 1 in sq pad size  
(Cu area = 1.127 in sq [1 oz] including traces).

**NTJD4158C, NVJD4158C****ELECTRICAL CHARACTERISTICS** ( $T_J = 25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	N/P	Test Condition	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b> (Note 3)							
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	N	$V_{GS} = 0\text{ V}$	$I_D = 250\ \mu\text{A}$	30		V
		P		$I_D = -250\ \mu\text{A}$	-20		
Drain-to-Source Breakdown Voltage Temperature Coefficient	$V_{(BR)DSS}/T_J$	N			33		mV/ $^\circ\text{C}$
		P			-9.0		
Zero Gate Voltage Drain Current	$I_{DSS}$	N	$V_{GS} = 0\text{ V}, V_{DS} = 30\text{ V}$	$T_J = 25^\circ\text{C}$		1.0	$\mu\text{A}$
		P			$V_{GS} = 0\text{ V}, V_{DS} = -16\text{ V}$		
		N	$V_{GS} = 0\text{ V}, V_{DS} = 30\text{ V}$	$T_J = 125^\circ\text{C}$		0.5	
		P			$V_{GS} = 0\text{ V}, V_{DS} = -16\text{ V}$		0.5
Gate-to-Source Leakage Current	$I_{GSS}$	N	$V_{DS} = 0\text{ V}, V_{GS} = 10\text{ V}$			1.0	$\mu\text{A}$
		P	$V_{DS} = 0\text{ V}, V_{GS} = -4.5\text{ V}$			1.0	

**ON CHARACTERISTICS** (Note 2)

Gate Threshold Voltage	$V_{GS(TH)}$	N	$V_{GS} = V_{DS}$	$I_D = 100\ \mu\text{A}$	0.8	1.2	1.5	V
		P		$I_D = -250\ \mu\text{A}$	-0.45	-0.61	-1.5	
Negative Gate Threshold Temperature Coefficient	$V_{GS(TH)}/T_J$	N				3.2		mV/ $^\circ\text{C}$
		P				-2.7		
Drain-to-Source On Resistance	$R_{DS(on)}$	N	$V_{GS} = 4.5\text{ V}, I_D = 10\text{ mA}$			1.0	1.5	$\Omega$
		P	$V_{GS} = -4.5\text{ V}, I_D = -0.88\text{ A}$			0.215	0.260	
		N	$V_{GS} = 2.5\text{ V}, I_D = 10\text{ mA}$			1.5	2.5	
		P	$V_{GS} = -2.5\text{ V}, I_D = -0.71\text{ A}$			0.345	0.500	
Forward Transconductance	$g_{FS}$	N	$V_{DS} = 3.0\text{ V}, I_D = 10\text{ mA}$			0.08		S
		P	$V_{DS} = -10\text{ V}, I_D = -0.88\text{ A}$			3.0		

**CHARGES, CAPACITANCES AND GATE RESISTANCE**

Input Capacitance	$C_{ISS}$	N	$f = 1\text{ MHz}, V_{GS} = 0\text{ V}$	$V_{DS} = 5.0\text{ V}$		20	33	pF		
		P		$V_{DS} = -20\text{ V}$		155	225			
Output Capacitance	$C_{OSS}$	N		$V_{DS} = 5.0\text{ V}$		19	32			
		P		$V_{DS} = -20\text{ V}$		25	40			
Reverse Transfer Capacitance	$C_{RSS}$	N		$V_{DS} = 5.0\text{ V}$		7.25	12			
		P		$V_{DS} = -20\text{ V}$		18	30			
Total Gate Charge	$Q_{G(TOT)}$	N		$V_{GS} = 5.0\text{ V}, V_{DS} = 24\text{ V}, I_D = 0.1\text{ A}$			0.9		1.5	nC
		P		$V_{GS} = -4.5\text{ V}, V_{DS} = -10\text{ V}, I_D = -0.88\text{ A}$			2.2		3.5	
Threshold Gate Charge	$Q_{G(TH)}$	N		$V_{GS} = 5.0\text{ V}, V_{DS} = 24\text{ V}, I_D = 0.1\text{ A}$			0.2			
		P		$V_{GS} = -4.5\text{ V}, V_{DS} = -10\text{ V}, I_D = -0.88\text{ A}$			0.2			
Gate-to-Source Charge	$Q_{GS}$	N	$V_{GS} = 5.0\text{ V}, V_{DS} = 24\text{ V}, I_D = 0.1\text{ A}$			0.3				
		P	$V_{GS} = -4.5\text{ V}, V_{DS} = -10\text{ V}, I_D = -0.88\text{ A}$			0.5				
Gate-to-Drain Charge	$Q_{GD}$	N	$V_{GS} = 5.0\text{ V}, V_{DS} = 24\text{ V}, I_D = 0.1\text{ A}$			0.2				
		P	$V_{GS} = -4.5\text{ V}, V_{DS} = -10\text{ V}, I_D = -0.88\text{ A}$			0.65				

**SWITCHING CHARACTERISTICS** (Note 3)

Turn-On Delay Time	$t_{d(ON)}$	N	$V_{GS} = 4.5\text{ V}, V_{DD} = 5.0\text{ V}, I_D = 250\text{ mA}, R_G = 50\ \Omega$		15		ns	
Rise Time	$t_r$				66			
Turn-Off Delay Time	$t_{d(OFF)}$				56			
Fall Time	$t_f$				78			
Turn-On Delay Time	$t_{d(ON)}$	P		$V_{GS} = -4.5\text{ V}, V_{DD} = -10\text{ V}, I_D = -0.5\text{ A}, R_G = 20\ \Omega$		5.8		
Rise Time	$t_r$					6.5		
Turn-Off Delay Time	$t_{d(OFF)}$					13.5		
Fall Time	$t_f$					3.5		

**DRAIN-SOURCE DIODE CHARACTERISTICS**

Forward Diode Voltage	$V_{SD}$	N	$V_{GS} = 0\text{ V}, T_J = 25^\circ\text{C}$	$I_S = 10\text{ mA}$		0.65	0.7	V
		P		$I_S = -0.48\text{ A}$		-0.8	-1.2	
		N	$V_{GS} = 0\text{ V}, T_J = 125^\circ\text{C}$	$I_S = 10\text{ mA}$		0.45		
		P		$I_S = -0.48\text{ A}$		-0.66		
Reverse Recovery Time	$t_{RR}$	N	$V_{GS} = 0\text{ V}, dI_S/dt = 8.0\text{ A}/\mu\text{s}$	$I_S = 10\text{ mA}$		12.4		ns
		P	$V_{GS} = 0\text{ V}, dI_S/dt = 100\text{ A}/\mu\text{s}$	$I_S = -0.48\text{ mA}$		10.6		

2. Pulse Test: pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ .

3. Switching characteristics are independent of operating junction temperatures.

# NTJD4158C, NVJD4158C

## TYPICAL N-CHANNEL PERFORMANCE CURVES ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

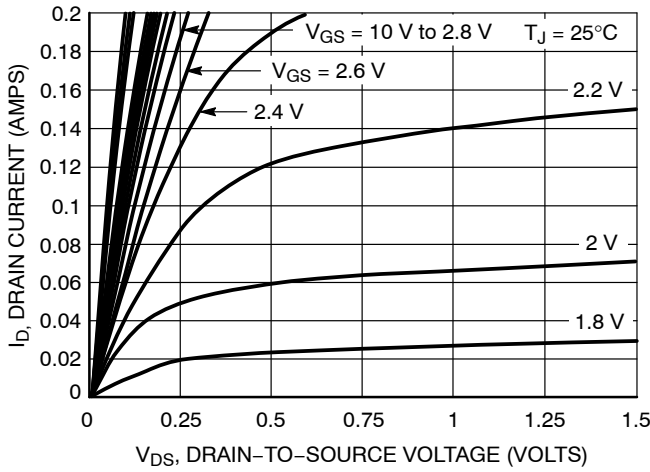


Figure 1. On-Region Characteristics

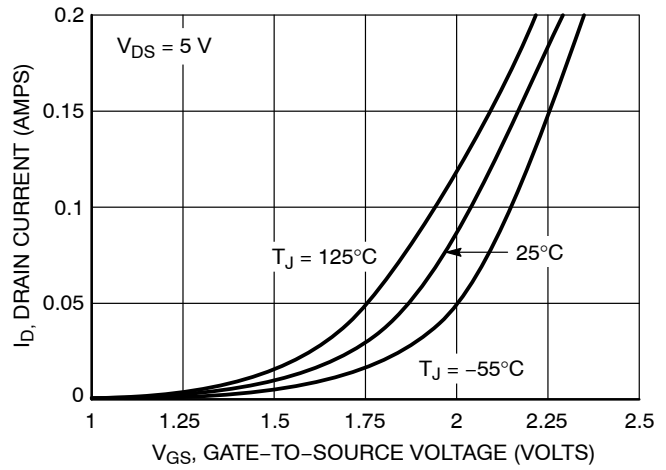


Figure 2. Transfer Characteristics

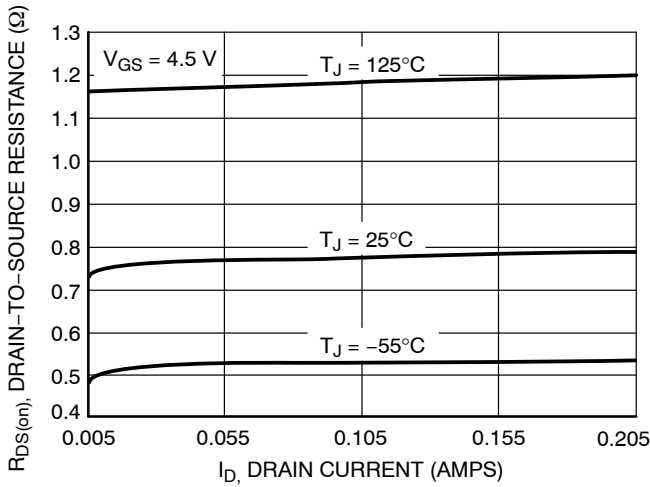


Figure 3. On-Resistance vs. Drain Current and Temperature

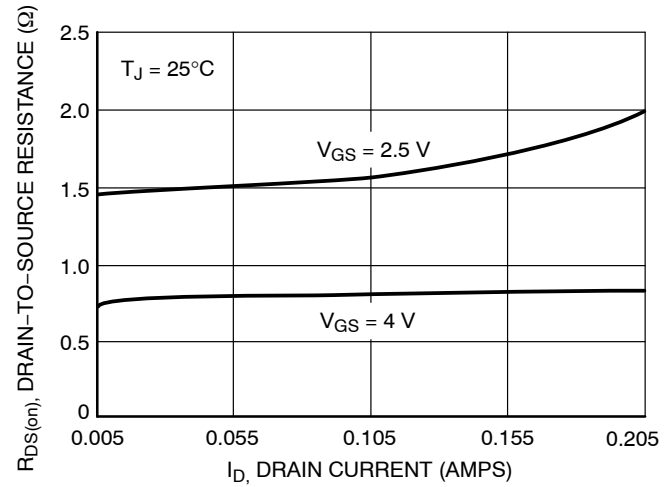


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

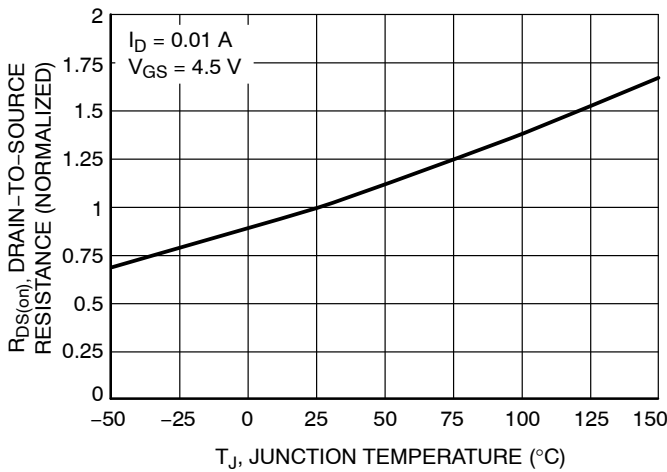


Figure 5. On-Resistance Variation with Temperature

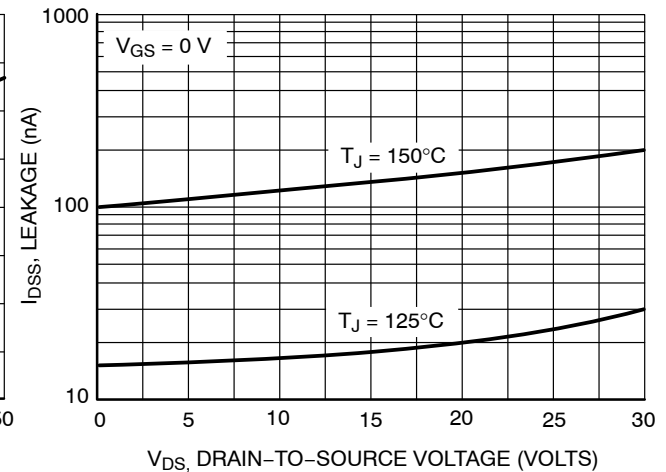
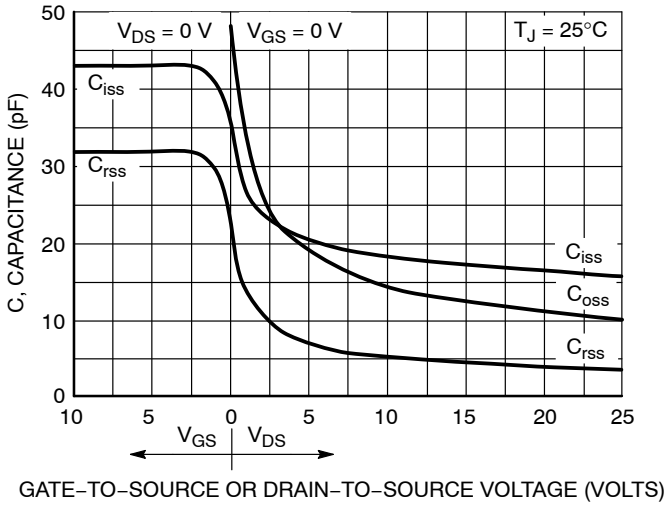


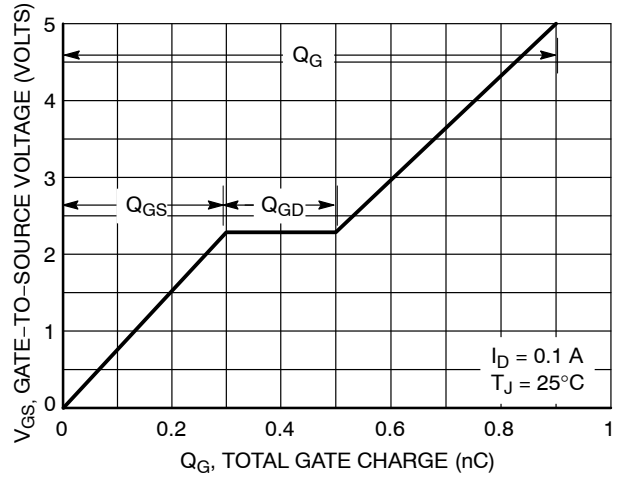
Figure 6. Drain-to-Source Leakage Current vs. Voltage

**NTJD4158C, NVJD4158C**

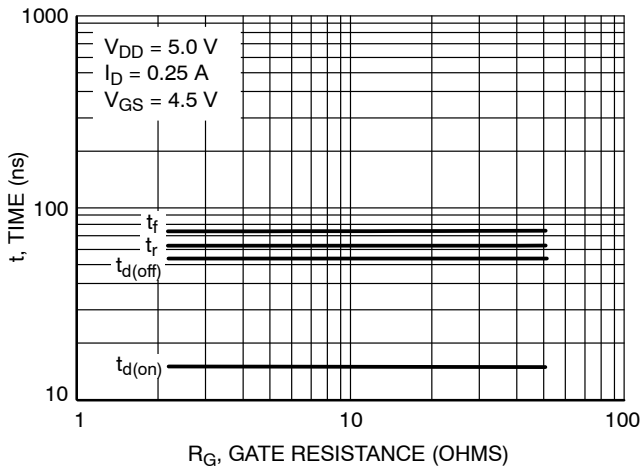
**TYPICAL N-CHANNEL PERFORMANCE CURVES** ( $T_J = 25^\circ\text{C}$  unless otherwise noted)



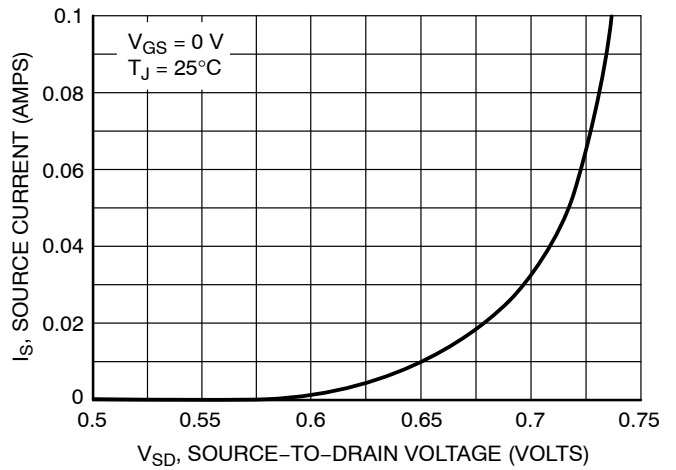
**Figure 7. Capacitance Variation**



**Figure 8. Gate-to-Source Voltage vs. Total Gate Charge**



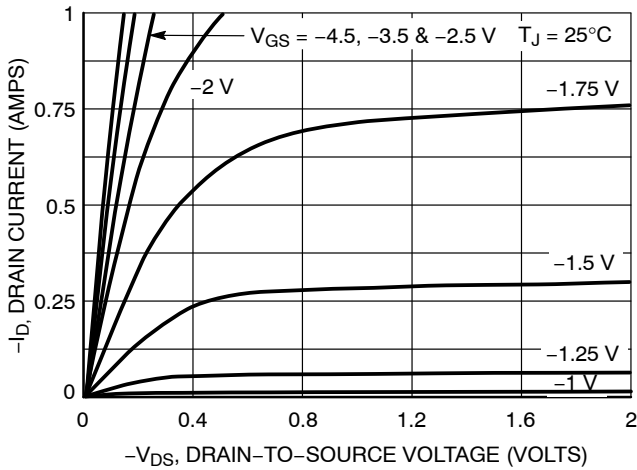
**Figure 9. Resistive Switching Time Variation vs. Gate Resistance**



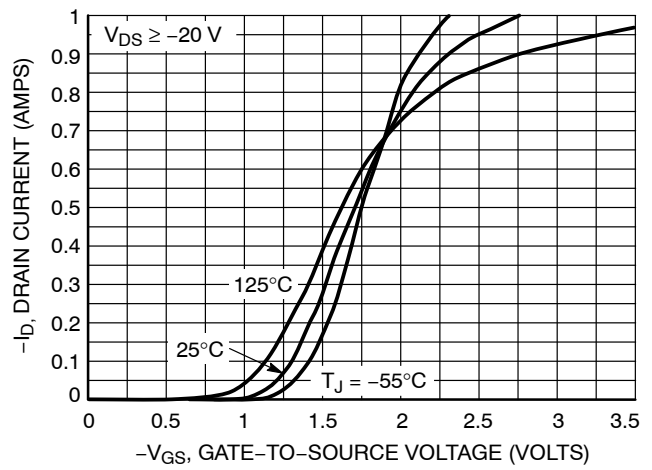
**Figure 10. Diode Forward Voltage vs. Current**

**NTJD4158C, NVJD4158C**

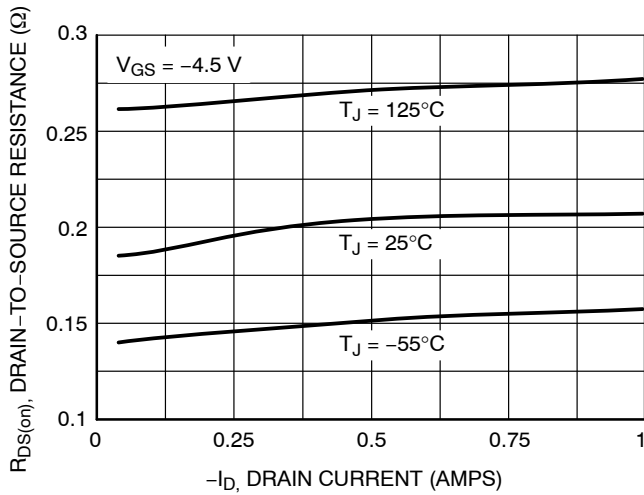
**TYPICAL P-CHANNEL PERFORMANCE CURVES** ( $T_J = 25^\circ\text{C}$  unless otherwise noted)



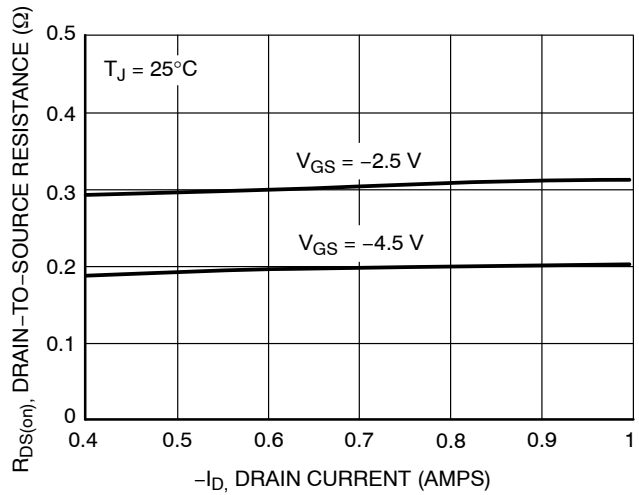
**Figure 1. On-Region Characteristics**



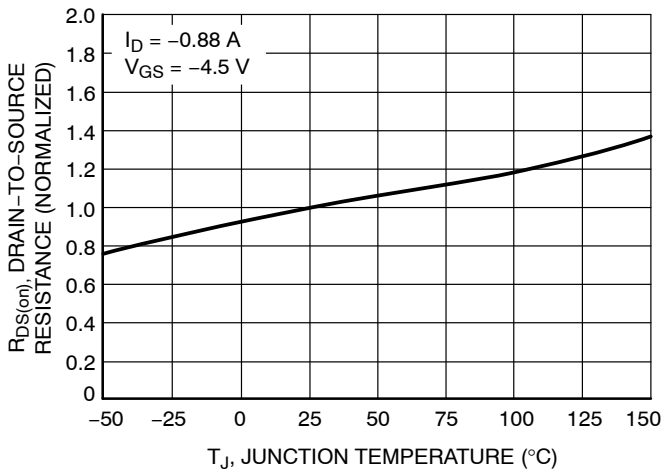
**Figure 2. Transfer Characteristics**



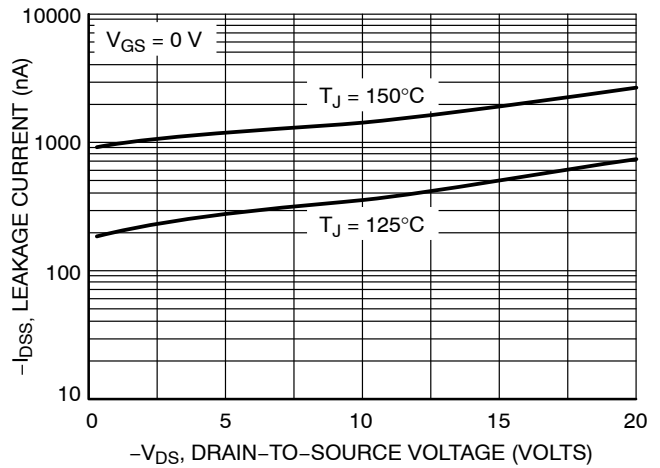
**Figure 3. On-Resistance vs. Drain Current and Temperature**



**Figure 4. On-Resistance vs. Drain Current and Gate Voltage**



**Figure 5. On-Resistance Variation with Temperature**



**Figure 6. Drain-to-Source Leakage Current vs. Voltage**



### NTJD4158C, NVJD4158C

#### TYPICAL P-CHANNEL PERFORMANCE CURVES (T<sub>J</sub> = 25°C unless otherwise noted)

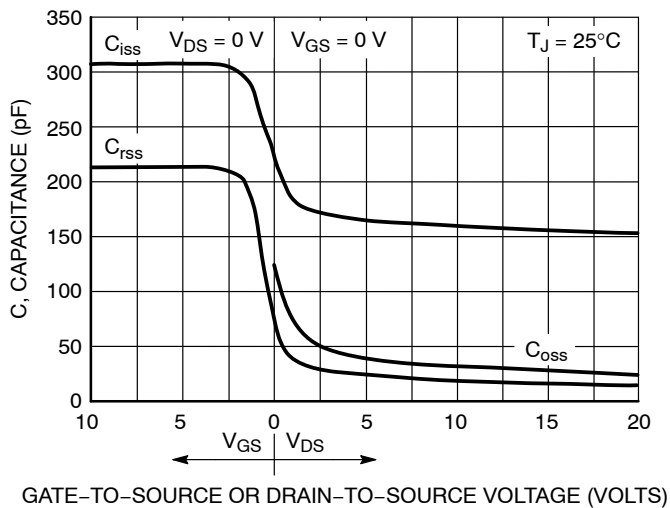


Figure 7. Capacitance Variation

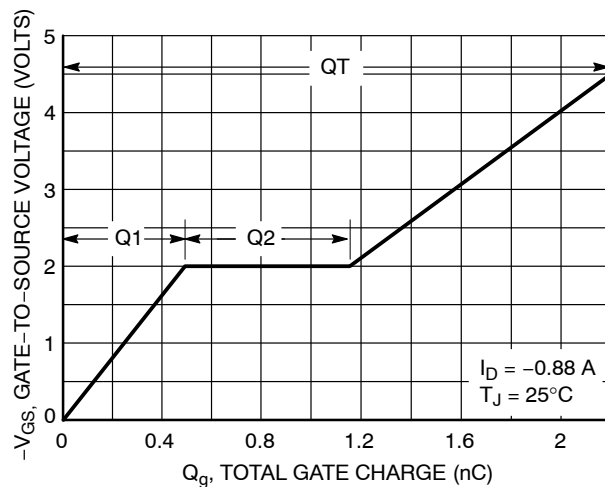


Figure 8. Gate-to-Source Voltage vs. Total Gate Charge

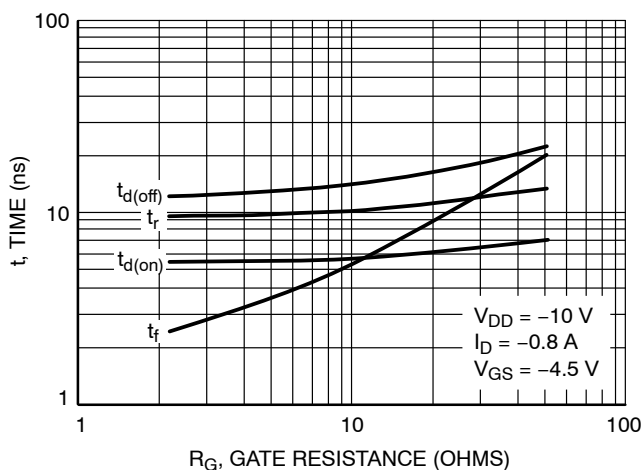


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

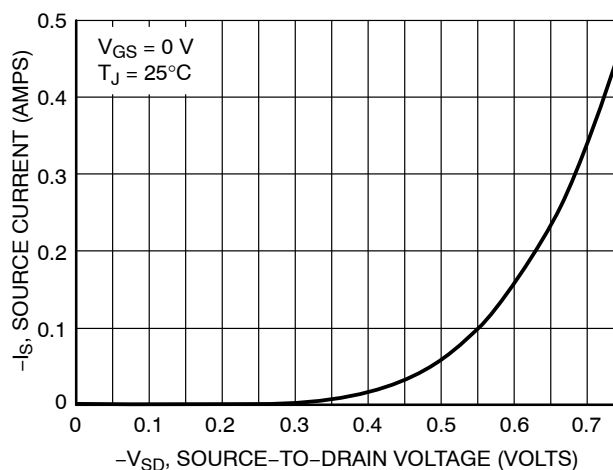


Figure 10. Diode Forward Voltage vs. Current

#### ORDERING INFORMATION

Device	Marking	Package	Shipping†
NTJD4158CT1G	TCD	SC-88 (Pb-Free)	3000 / Tape & Reel
NTJD4158CT2G	TCD		
NVJD4158CT1G*	VCD		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.



**MECHANICAL CASE OUTLINE  
PACKAGE DIMENSIONS**

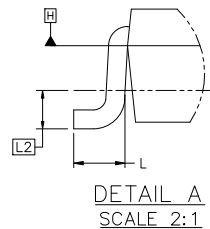
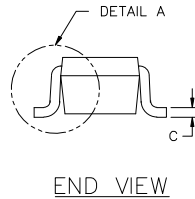
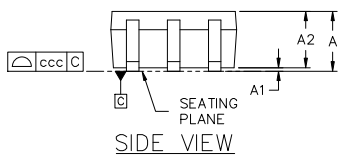
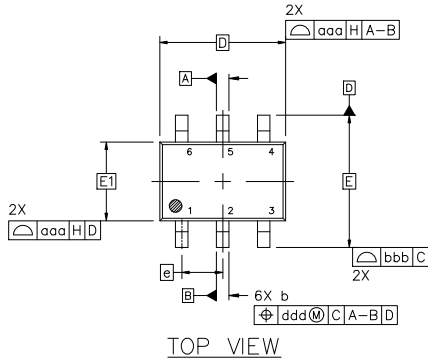


**SC-88 2.00x1.25x0.90, 0.65P**  
CASE 419B-02  
ISSUE Z

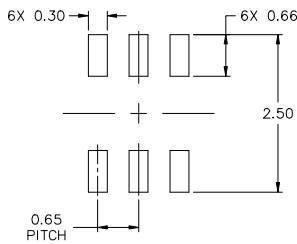
DATE 18 APR 2024

NOTES:

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018.
2. ALL DIMENSION ARE IN MILLIMETERS.
3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END.
4. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H.
5. DATUMS A AND B ARE DETERMINED AT DATUM H.
6. DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.
7. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION b AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

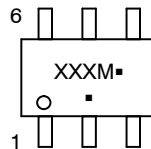


DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	---	---	1.10
A1	0.00	---	0.10
A2	0.70	0.90	1.00
b	0.15	0.20	0.25
c	0.08	0.15	0.22
D	2.00 BSC		
E	2.10 BSC		
E1	1.25 BSC		
e	0.65 BSC		
L	0.26	0.36	0.46
L2	0.15 BSC		
aaa	0.15		
bbb	0.30		
ccc	0.10		
ddd	0.10		



\* FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

**GENERIC MARKING DIAGRAM\***



- XXX = Specific Device Code
- M = Date Code\*
- = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

**STYLES ON PAGE 2**

<b>DOCUMENT NUMBER:</b>	<b>98ASB42985B</b>	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
<b>DESCRIPTION:</b>	<b>SC-88 2.00x1.25x0.90, 0.65P</b>	<b>PAGE 1 OF 2</b>

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**SC-88 2.00x1.25x0.90, 0.65P**  
**CASE 419B-02**  
**ISSUE Z**

DATE 18 APR 2024

<b>STYLE 1:</b> PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	<b>STYLE 2:</b> CANCELLED	<b>STYLE 3:</b> CANCELLED	<b>STYLE 4:</b> PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	<b>STYLE 5:</b> PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	<b>STYLE 6:</b> PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
<b>STYLE 7:</b> PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	<b>STYLE 8:</b> CANCELLED	<b>STYLE 9:</b> PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	<b>STYLE 10:</b> PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	<b>STYLE 11:</b> PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	<b>STYLE 12:</b> PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
<b>STYLE 13:</b> PIN 1. ANODE 2. N/C 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	<b>STYLE 14:</b> PIN 1. VREF 2. GND 3. GND 4. IOUT 5. VEN 6. VCC	<b>STYLE 15:</b> PIN 1. ANODE 1 2. ANODE 2 3. ANODE 3 4. CATHODE 3 5. CATHODE 2 6. CATHODE 1	<b>STYLE 16:</b> PIN 1. BASE 1 2. EMITTER 2 3. COLLECTOR 2 4. BASE 2 5. EMITTER 1 6. COLLECTOR 1	<b>STYLE 17:</b> PIN 1. BASE 1 2. EMITTER 1 3. COLLECTOR 2 4. BASE 2 5. EMITTER 2 6. COLLECTOR 1	<b>STYLE 18:</b> PIN 1. VIN1 2. VCC 3. VOUT2 4. VIN2 5. GND 6. VOUT1
<b>STYLE 19:</b> PIN 1. IOUT 2. GND 3. GND 4. V CC 5. V EN 6. V REF	<b>STYLE 20:</b> PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER 5. COLLECTOR 6. COLLECTOR	<b>STYLE 21:</b> PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. N/C 6. CATHODE 1	<b>STYLE 22:</b> PIN 1. D1 (i) 2. GND 3. D2 (i) 4. D2 (c) 5. VBUS 6. D1 (c)	<b>STYLE 23:</b> PIN 1. Vn 2. CH1 3. Vp 4. N/C 5. CH2 6. N/C	<b>STYLE 24:</b> PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE
<b>STYLE 25:</b> PIN 1. BASE 1 2. CATHODE 3. COLLECTOR 2 4. BASE 2 5. EMITTER 6. COLLECTOR 1	<b>STYLE 26:</b> PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2 4. SOURCE 2 5. GATE 2 6. DRAIN 1	<b>STYLE 27:</b> PIN 1. BASE 2 2. BASE 1 3. COLLECTOR 1 4. EMITTER 1 5. EMITTER 2 6. COLLECTOR 2	<b>STYLE 28:</b> PIN 1. DRAIN 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN	<b>STYLE 29:</b> PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE/ANODE 6. CATHODE	<b>STYLE 30:</b> PIN 1. SOURCE 1 2. DRAIN 2 3. DRAIN 2 4. SOURCE 2 5. GATE 1 6. DRAIN 1

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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